

# FTR-B4 SERIES

## ■ SPECIFICATION

Item			Standard type	Latching type
			FTR-B4 ( ) A	FTR-B4 ( ) B
Contact Data	Configuration		2 form C	
	Construction		Bifurcated contacts	
	Material		Z: Gold overlay silver nickel / P: Gold overlay silver palladium	
	Resistance (Initial)		Max. 100 mΩ at 1 A, 6 VDC	
	Contact rating (resistive)		30VDC, 1A / 125VAC, 0.3A	
	Max. carrying current		2A	
	Max. switching voltage		250 VAC / 220VDC	
	Max. switching power		62.5VA / 30W	
	Min. switching load *		0.01mA, 10mVDC	
Life	Mechanical		Min. 50 x 10 <sup>6</sup> operations	Min. 20 x 10 <sup>6</sup> operations
	Electrical	DC load	Min. 100 x 10 <sup>3</sup> operations at 1A, 30VDC	
		AC load	Min. 100 x 10 <sup>3</sup> operations at 0.3A, 125VAC	
Coil Data	Rated power		140mW - 230mW	100mW - 130mW
	Applied pulse width		-	Min. 10ms
	Operate power		80mW - 130mW	57mW - 68mW
	Operating temperature range		-40 °C to +85 °C (no frost)	
	Storage temperature / humidity		-40 °C to +85 °C / 5% to 85% RH (no frost)	
Timing Data	Operate (at nominal voltage, no bounce)		Max. 3 ms	Max. 3 ms (set)
	Release (at nominal voltage, no bounce)		Max. 3 ms	Max. 3 ms (reset)
Insulation	Resistance (initial)		Min. 1,000MΩ at 500VDC	
	Dielectric strength	Open contacts	1,000VAC (50/60Hz) 1min	
		Contacts to coil	1,500VAC (50/60Hz) 1min	
		Adjacent contacts	1,000VAC (50/60Hz) 1min.	
	Surge strength	Coil to contacts	2,500V, 2 x 10μs standard wave	
		Adjacent contacts	1.0 mm	
	Clearance	Open contacts	0.28 mm	
		Coil and contacts	1.0 mm	
		Adjacent contacts	1.0 mm	
	Creepage	Open contacts	0.28 mm	
Coil and contacts		1.60 mm		
Adjacent contacts		1.0 mm		
Other	Vibration resistance	Misoperation	10 to 55 to 10Hz at single amplitude 1.65 mm	
		Endurance	10 to 55 to 10Hz at single amplitude 2.5 mm	
	Shock	Misoperation	750m/s <sup>2</sup> (11 ±1ms)	
		Endurance	1,000m/s <sup>2</sup> (6 ±1ms)	
	Weight	Approximately 1 g		
	Sealing	RT III (plastic sealed)		

\* Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

## ■ COIL RATING

Standard type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
1.5	1.5	16.1	1.13	0.15	140
003	3	64.3	2.25	0.3	
4.5	4.5	145	3.38	0.45	
006	6	257	4.5	0.6	
009	9	579	6.75	0.9	
012	12	1,028	9.0	1.2	230
024	24	2,504	18.0	2.4	

Latching type (1 coil)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Set Voltage (VDC) *	Reset Voltage (VDC) *	Set/Reset current (mA)	Rated Power (mW)
1.5	1.5	22.5	+1.13	-1.13	50	100
003	3	90	+2.25	-2.25	25	
4.5	4.5	203	+3.38	-3.38	17	
006	6	360	+4.5	-4.5	13	
009	9	810	+6.75	-6.75	8	
012	12	1,440	+9.0	-9.0	6	120
024	24	4,800	+18.0	-18.0	4	

Note: All values in the table are valid for 20°C and zero contact current.  
\* Specified operate values are valid for pulse wave voltage..

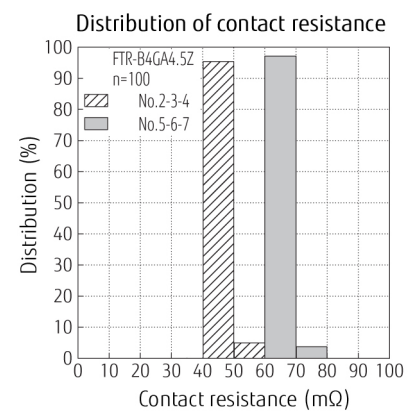
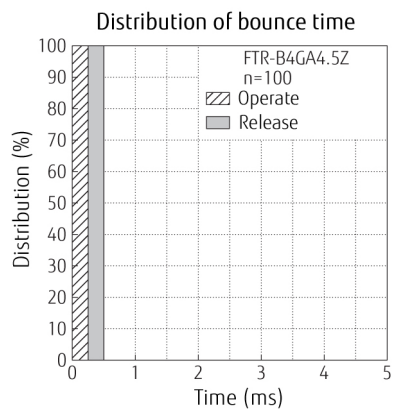
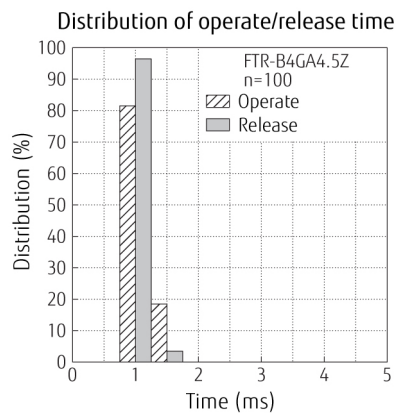
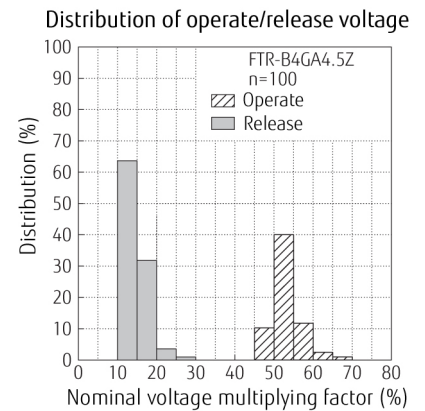
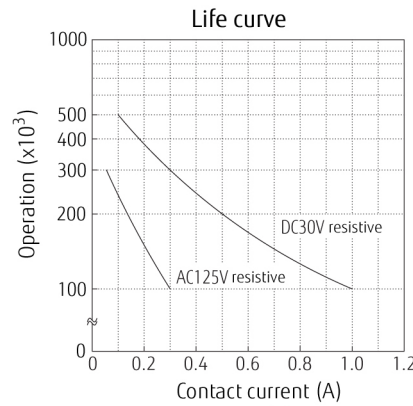
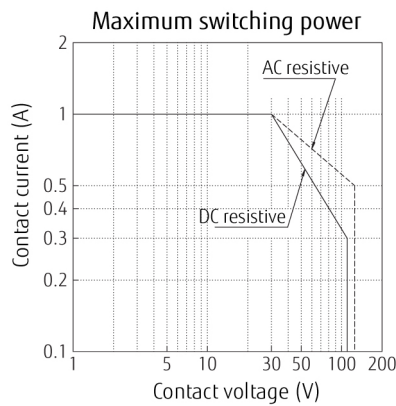
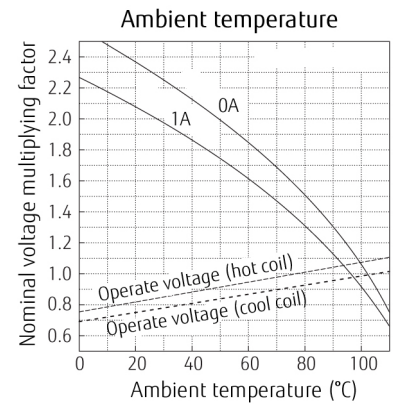
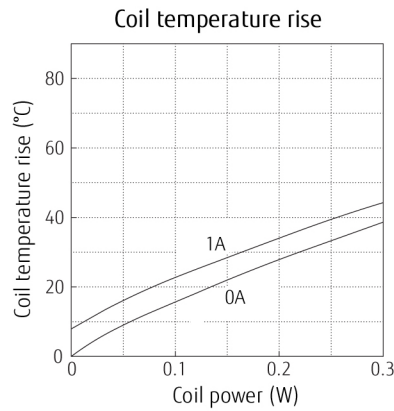
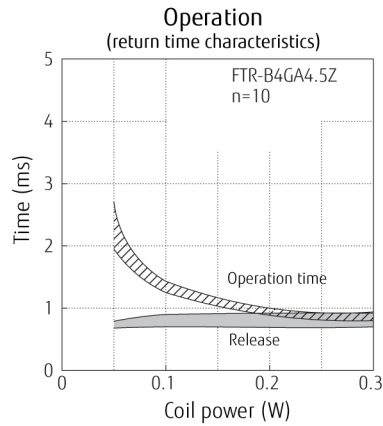
## ■ SAFETY STANDARDS

Type	Compliance	Contact rating
UL	UL 508	Flammability: UL 94-V0 (plastics)
	E 63615	0.5A, 125VAC (resistive) 1A, 30VDC
CSA	C22.2 No. 14 LR 40304	0.3A, 110VDC 2A, 30VDC

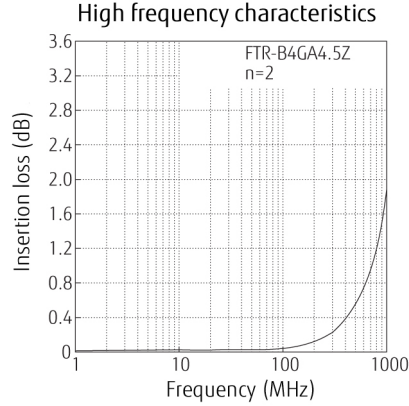
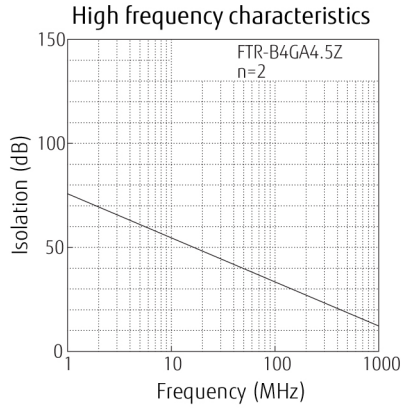
Comply with Telcordia specifications and FCC part 68 and meet BSI EN60950-1:  
Marking only for UL, CSA

## CHARACTERISTIC DATA (Reference)

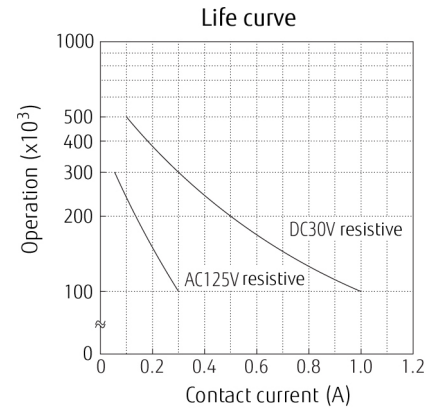
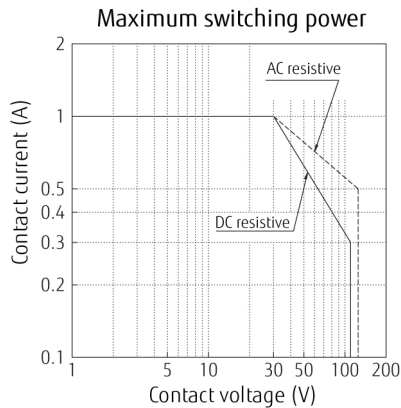
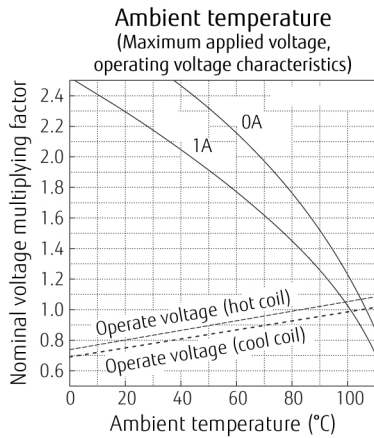
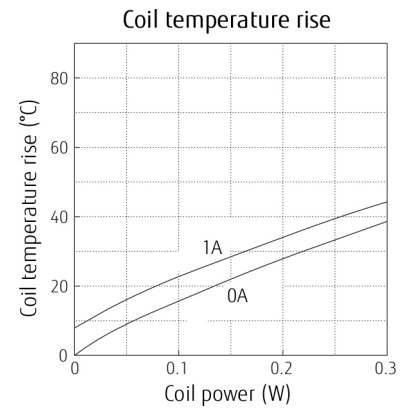
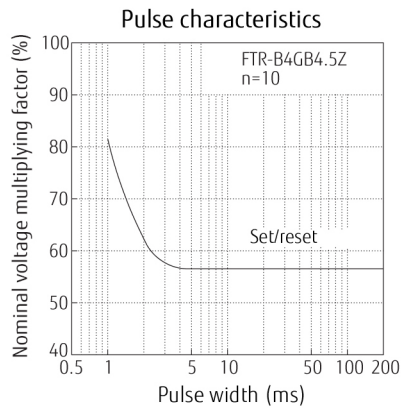
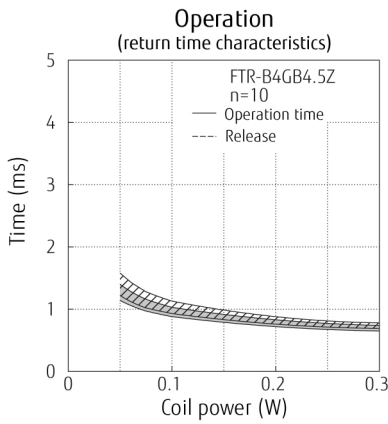
- Standard type



# FTR-B4 SERIES

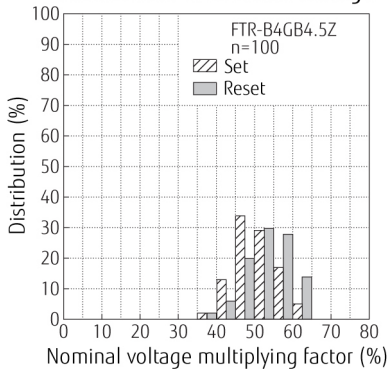


- **Latching type (1coil)**

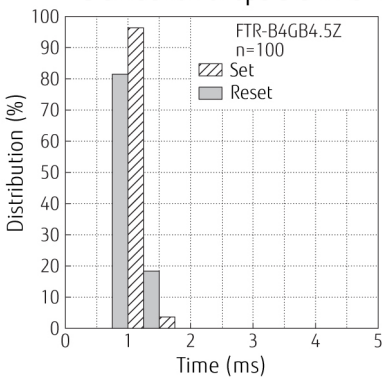


# FTR-B4 SERIES

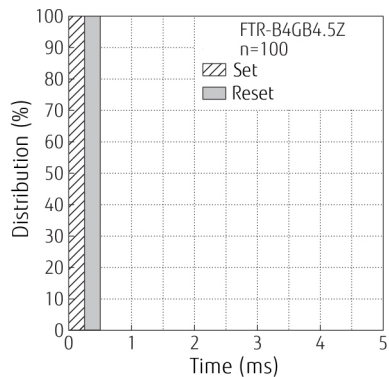
Distribution of set/reset voltage



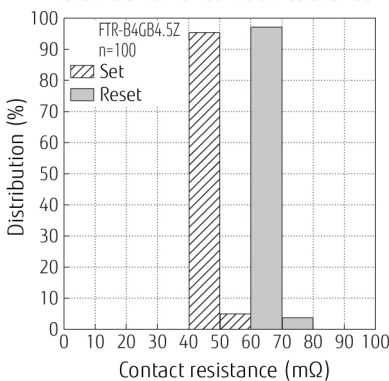
Distribution of operate time



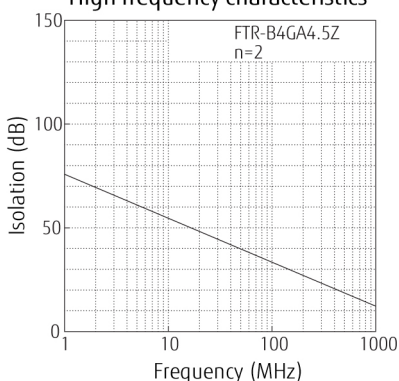
Distribution of bounce time



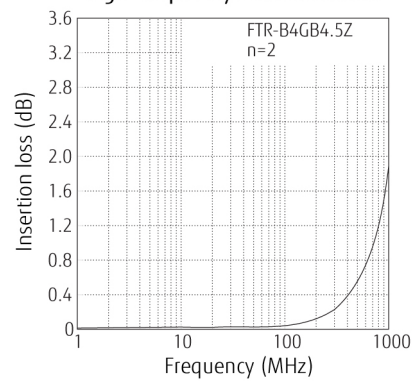
Distribution of contact resistance



High frequency characteristics



High frequency characteristics

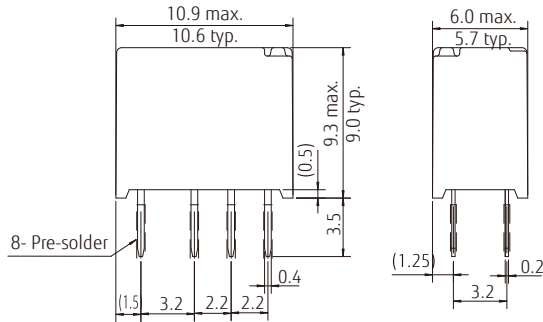


# FTR-B4 SERIES

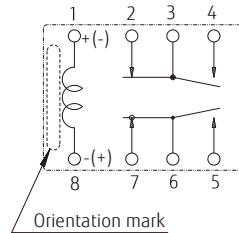
## ■ DIMENSIONS

### FTR-B4C - Through hole type

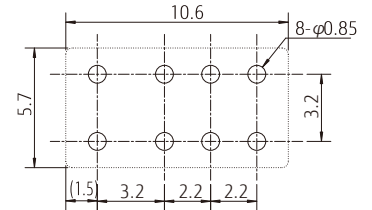
#### ● Dimensions



#### ● Schematics \* (BOTTOM VIEW)

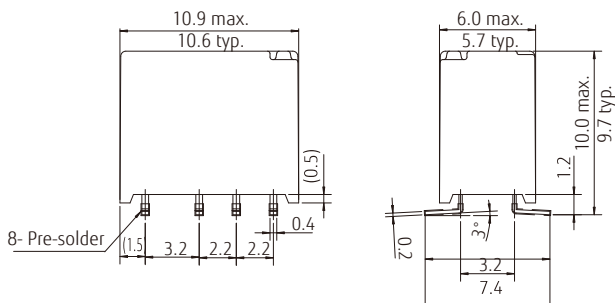


#### ● PC board mounting hole layout (BOTTOM VIEW)

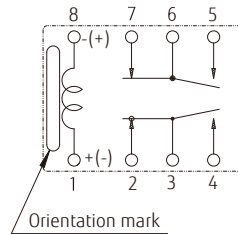


### FTR-B4G - Surface mount type

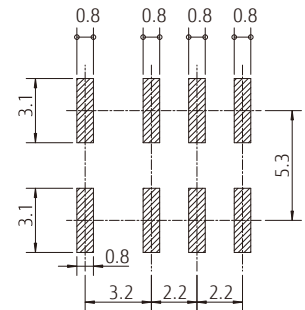
#### ● Dimensions



#### ● Schematics \* (TOP VIEW)

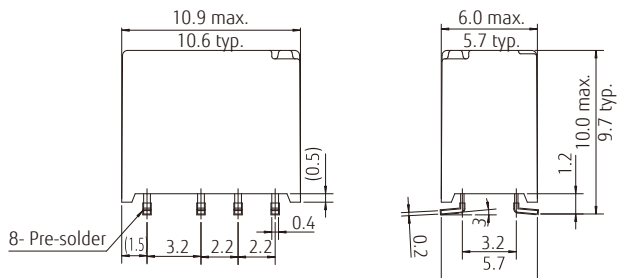


#### ● PC board mounting pad layout (TOP VIEW)

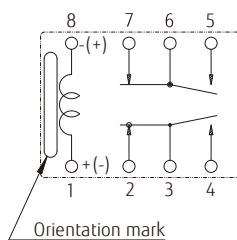


### FTR-B4S- Space saving type

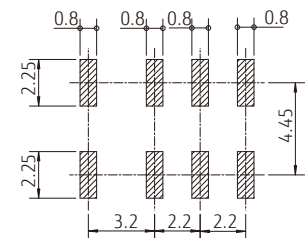
#### ● Dimensions



#### ● Schematics \* (TOP VIEW)



#### ● PC board mounting pad layout (TOP VIEW)



\* Contact indicates reset state for latching relays (FTR-B4CB, FTR-B4GB and FTR-B4SB versions) and non-operate state for standard relays (FTR-B4CA, FTR-B4GA and FTR-B4SA versions).

\* +/-: Apply set voltage for latching relays, operate voltage for standard relays.  
(+)/(−): Indicates set state for latching relays, operate state for standard relays.

Note: Tolerance for PC board mounting hole/pad layout: +/-0.1.

Note: Dimensions of the terminals do not include thickness of pre-solder.

Unit: mm  
( ): Reference



## General information

### 1. ROHS COMPLIANCE

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Use of cadmium in electrical contacts is exempted as per Annex III of the RoHS directive 2011/65/EU. Please consider expiry date of exemption. Relays with cadmium containing contacts are not to be used for new designs.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: <http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf>

### 2. Recommended Lead Free Solder Condition

- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.
- Recommended solder Sn-3.0Ag-0.5Cu.

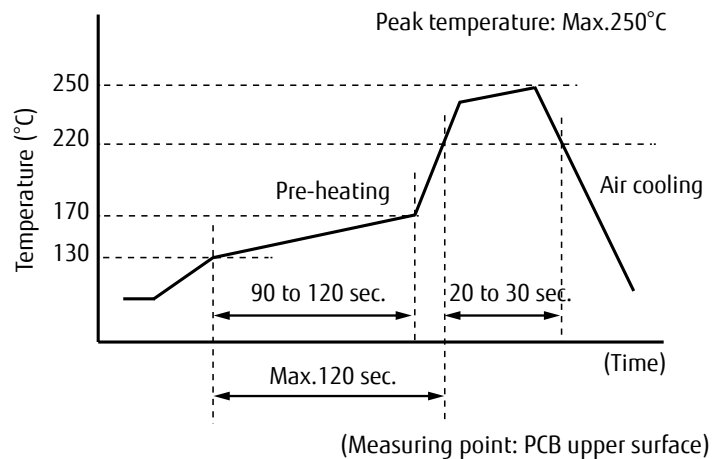
#### Flow Solder Condition:

Pre-heating: maximum 120 °C within 90 sec.  
 Soldering: dip within 5 sec. at 255 °C ± 5 °C solder bath  
 Relay must be cooled by air immediately after soldering

#### Solder by Soldering Iron:

Soldering Iron 30-60W  
 Temperature: maximum 340-360 °C  
 Duration: maximum 3 sec.

#### Reflow Solder Condition for SMT



**We highly recommend that you confirm your actual solder conditions**

### 3. Moisture Sensitivity

- SMT versions of FTR-B4 relays in Tape & Reel package will be shipped in Moisture Barrier Bag (MBB).
- Moisture Sensitivity Level (MSL) of FTR-B4 relay is indicated on the packing caution label.
- Relays must be stored in the unopened MBB at storage conditions <40C/90%RH for a maximum 1 year
- SMT versions of FTR-B4 relays in tube packing will not be shipped in MBB. Therefore, these relays shall be dried by baking before reflow soldering process according to IPC/JEDEC J-STD-033.

### 4. Tin Whiskers

- Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.



## Cautions

- All values mentioned in this datasheet are provided under ideal conditions. Please perform the confirmation test before actual use.
- Reflow soldering is prohibited for through hole relays.
- Do not use relays in the atmosphere with sulfide gas, chloride gas or nitric oxide. Contact resistance may increase.
- Do not use silicon or silicon-containing product or materials near relays. It may cause contact failure.

## Cautions for latching relays

- Latching relays are shipped in the state set, but state may change due to shock during transportation or mounting. Before using the relays, it is advisable to bring the relays in necessary state (set or reset) and program a circuit sequence. Otherwise, it will or will not operate simultaneously with power activation.
- Please connect relay coils according to specified polarity.
- Do not apply voltage to both set coil and reset coil at a time.

## Fujitsu Components International Headquarter Offices

### Japan

FUJITSU COMPONENT LIMITED  
Shinagawa Seaside Park Tower 19F,  
12-4, Higashi-shinagawa 4-chome, Shinagawa-ku,  
Tokyo, 140-0002, Japan  
Tel: (81-3) 3450-1682  
Fax: (81-3) 3474-2385  
Email: fcl-contact@cs.jp.fujitsu.com  
Web: www.fujitsu.com/jp/fcl/

### Asia Pacific

FUJITSU COMPONENTS ASIA, LTD.  
102E Pasir Panjang Road  
#01-01 Citilink Warehouse Complex  
Singapore 118529  
Tel: (65) 6375-8560  
Fax: (65) 6273-3021  
Email: fcal@sg.fujitsu.com  
Web: www.fujitsu.com/sg/products/devices/components

### Korea

FUJITSU COMPONENTS KOREA LIMITED  
Alpha Tower #403, 645 Samsyeong-dong,  
Bundang-gu, Seongnam-si, Gyeonggi-do,  
13524 Korea  
Tel: (82) 31-708-7108  
Fax: (82) 31-709-7108  
Email: fcal@sg.fujitsu.com  
www.fujitsu.com/sg/products/devices/components/

### North and South America

FUJITSU COMPONENTS AMERICA, INC  
2290 North First Street, Suite 212  
San Jose, CA 95131, USA  
Tel: (1-408) 745-4900  
Fax: (1-408) 745-4970  
Email: components@us.fujitsu.com  
Web: us.fujitsu.com/components

### China

FUJITSU ELECTRONIC COMPONENTS (SHANGHAI) CO., LTD.  
Unit 4306, InterContinental Center  
100 Yu Tong Road, Shanghai 200070,  
China  
Tel: (86-21) 3253 0998  
Fax: (86-21) 3253 0997  
Email: fclsh@cn.fujitsu.com  
Web: www.fujitsu.com/cn/products/devices/components/

### Europe

FUJITSU COMPONENTS EUROPE B.V.  
Diamantlaan 25  
2132 WV Hoofddorp  
Netherlands  
Tel: (31-23) 5560910  
Fax: (31-23) 5560950  
Email: info@fceu.fujitsu.com  
Web: www.fujitsu.com/uk/components

### Hong Kong

FUJITSU COMPONENTS HONG KONG CO., LTD  
Unit 506, Inter-Continental Plaza  
No.94 Granville Road, Tsim Sha Tsui, Kowloon,  
Hong Kong  
Tel: (852) 2881-8495  
Tex: (852) 2894-9512  
Email: fcal@sg.fujitsu.com  
Web: www.fujitsu.com/sg/products/devices/components/

©2019 Fujitsu Components Europe B.V. All rights reserved. All trademarks or registered trademarks are the property of their respective owners.

The contents, data and information in this datasheet are provided by Fujitsu Component Ltd. as a service only to its user and only for general information purposes. The use of the contents, data and information provided in this datasheet is at the users' own risk.

Fujitsu has assembled this datasheet with care and will endeavor to keep the contents, data and information correct, accurate, comprehensive, complete and up to date.

Fujitsu Components Europe B.V. and affiliated companies do however not accept any responsibility or liability on their behalf, nor on behalf of its employees, for any loss or damage, direct, indirect or consequential, with respect to this datasheet, its contents, data, and information and related graphics and the correctness, reliability, accuracy, comprehensiveness, usefulness, availability and completeness thereof.

Nor do Fujitsu Components Europe B.V. and affiliated companies accept on their behalf, nor on behalf of its employees, any responsibility or liability with respect to these datasheets, its contents, data, information and related graphics and the correctness, reliability, accuracy, comprehensiveness, usefulness, availability and completeness thereof. Rev. September 18th, 2019